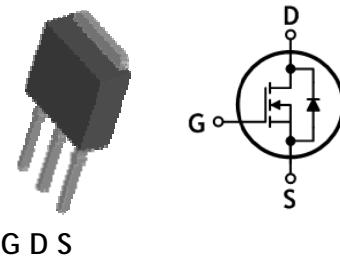


SWITCHING REGULATOR APPLICATION

Features

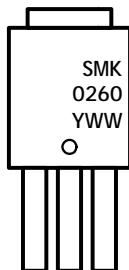
- Drain-Source breakdown voltage: $BV_{DSS}=600V$ (Min.)
- Low gate charge: $Q_g=7nC$ (Typ.)
- Low drain-source On resistance: $R_{DS(on)}=3.9\Omega$ (Typ.)
- 100% avalanche tested
- RoHS compliant device



Ordering Information

Part Number	Marking	Package
SMK0260IS	SMK0260	I-PAK (Short Lead)

Marking Information



Column 1, 2: Device Code
Column 3: Production Information
e.g.) YWW
-. Y: Year Code
-. WW: Week Code

Absolute maximum ratings ($T_c=25^\circ C$ unless otherwise noted)

Characteristic	Symbol		Rating	Unit
Drain-source voltage	V_{DSS}		600	V
Gate-source voltage	V_{GSS}		± 30	V
Drain current (DC) *	I_D	$T_c=25^\circ C$	2	A
		$T_c=100^\circ C$	1.35	A
Drain current (Pulsed) *	I_{DM}		8	A
Avalanche current ^(Note 2)	I_{AS}		2	A
Single pulsed avalanche energy ^(Note 2)	E_{AS}		130	mJ
Repetitive avalanche current ^(Note 1)	I_{AR}		2	A
Repetitive avalanche energy ^(Note 1)	E_{AR}		5.6	mJ
Power dissipation	P_D		48	W
Junction temperature	T_J		150	°C
Storage temperature range	T_{stg}		-55~150	°C

* Limited only maximum junction temperature

Thermal Characteristics

Characteristic	Symbol	Rating	Unit
Thermal resistance, junction to case	$R_{th(j-c)}$	Max. 2.6	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	Max. 62.5	

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{GS}=0$	600	-	-	V
Gate threshold voltage	$V_{GS(\text{th})}$	$I_D=250\mu\text{A}, V_{DS}=V_{GS}$	2.0	-	4.0	V
Drain-source cut-off current	I_{DSS}	$V_{DS}=600\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
Gate leakage current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$	-	-	± 100	nA
Drain-source on-resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=1\text{A}$	-	3.9	4.7	Ω
Internal gate resistance	R_G	$f=1\text{MHz}, V_{DS}=0\text{V}$	-	1.25	6.25	Ω
Forward transfer conductance ^(Note 3)	g_{fs}	$V_{DS}=10\text{V}, I_D=1\text{A}$	-	5	-	S
Input capacitance	C_{iss}	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	-	250	-	pF
Output capacitance	C_{oss}		-	20	-	
Reverse transfer capacitance	C_{rss}		-	3.4	-	
Turn-on delay time ^(Note 3,4)	$t_{d(on)}$	$V_{DD}=300\text{V}, I_D=2\text{A}$ $R_G=25\Omega$	-	9	-	ns
Rise time ^(Note 3,4)	t_r		-	25	-	
Turn-off delay time ^(Note 3,4)	$t_{d(off)}$		-	24	-	
Fall time ^(Note 3,4)	t_f		-	28	-	
Total gate charge ^(Note 3,4)	Q_g	$V_{DS}=480\text{V}, V_{GS}=10\text{V}$ $I_D=2\text{A}$	-	7	9.5	nC
Gate-source charge ^(Note 3,4)	Q_{gs}		-	1.5	-	
Gate-drain charge ^(Note 3,4)	Q_{gd}		-	4.7	-	

Source-Drain Diode Ratings and Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Source current (DC)	I_S	Integral reverse diode in the MOSFET	-	-	2	A
Source current (Pulsed)	I_{SM}		-	-	8	A
Forward voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=2\text{A}$	-	-	1.4	V
Reverse recovery time ^(Note 3,4)	t_{rr}	$I_S=2\text{A}, V_{GS}=0\text{V}$ $dI_S/dt=-100\text{A}/\mu\text{s}$	-	230	-	ns
Reverse recovery charge ^(Note 3,4)	Q_{rr}		-	1	-	μC

Note:

1. Repeated rating: Pulse width limited by safe operating area
2. L=59.5mH, $I_{AS}=2\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. Pulse test: Pulse width $\leq 300\text{us}$, Duty cycle $\leq 2\%$
4. Essentially independent of operating temperature typical characteristics

Electrical Characteristic Curves

Fig. 1 I_D - V_{DS}

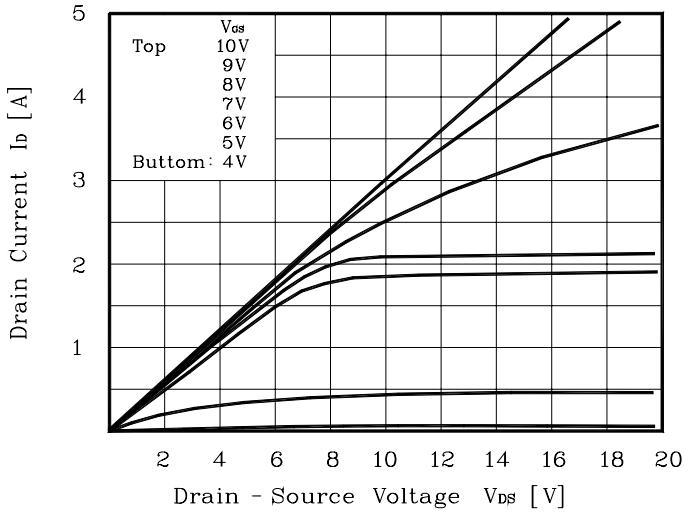


Fig. 2 I_D - V_{GS}

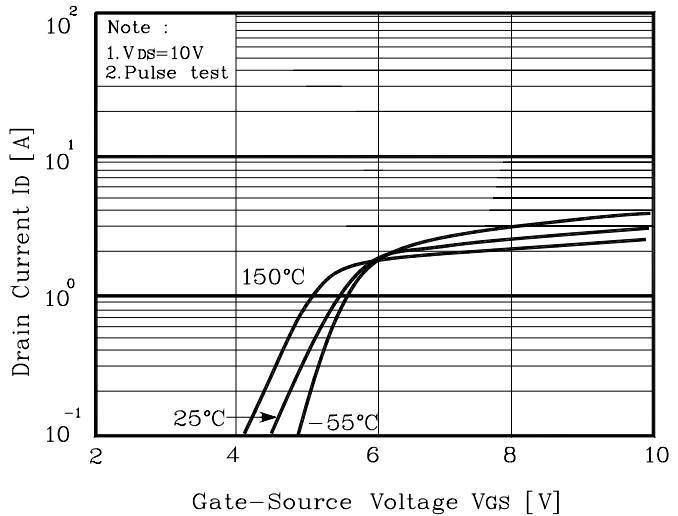


Fig. 3 $R_{DS(on)}$ - I_D

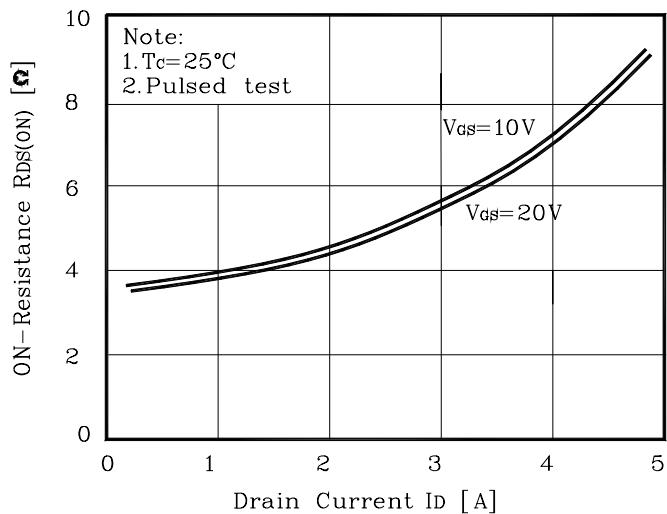


Fig. 4 I_S - V_{SD}

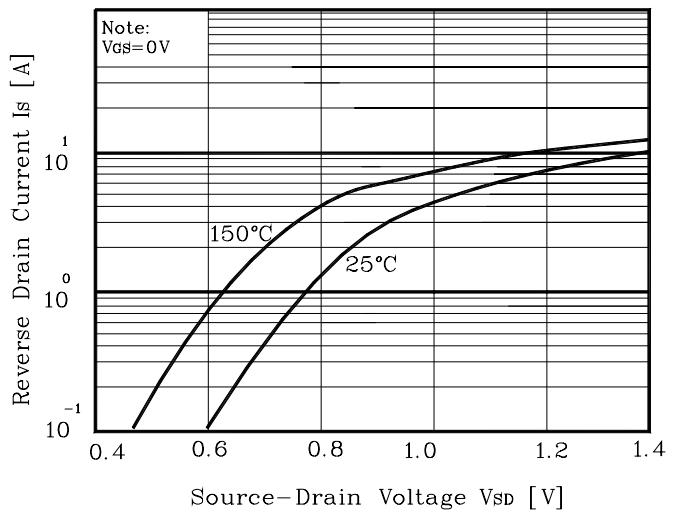


Fig. 5 Capacitance - V_{DS}

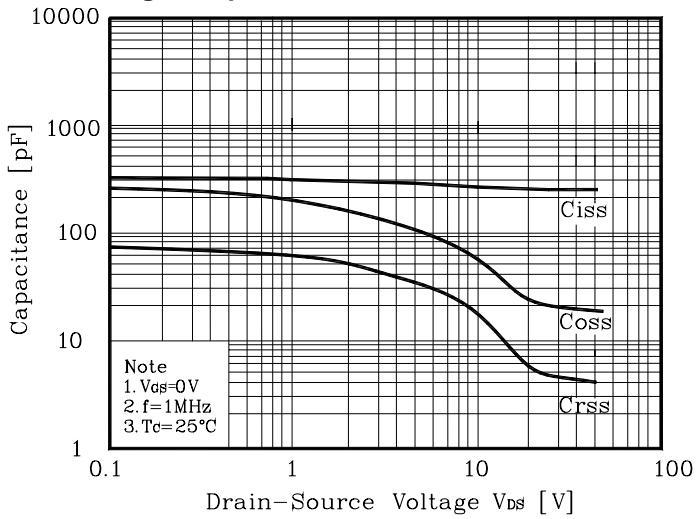
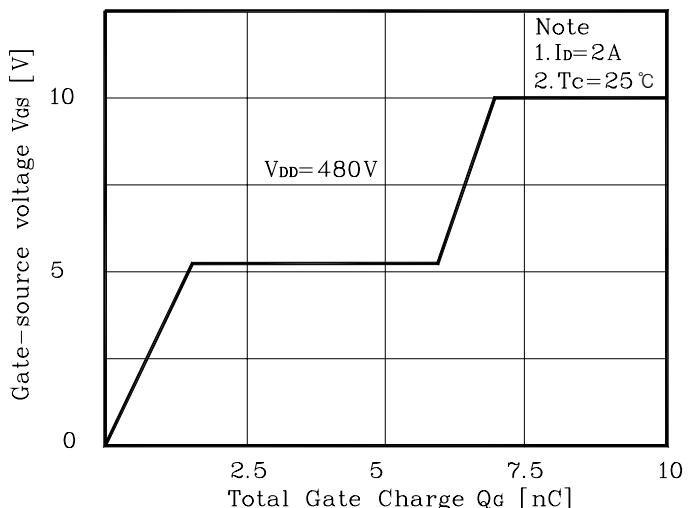


Fig. 6 V_{GS} - Q_G



Electrical Characteristic Curves (Continue)

Fig. 7 V_{DSS} - T_J

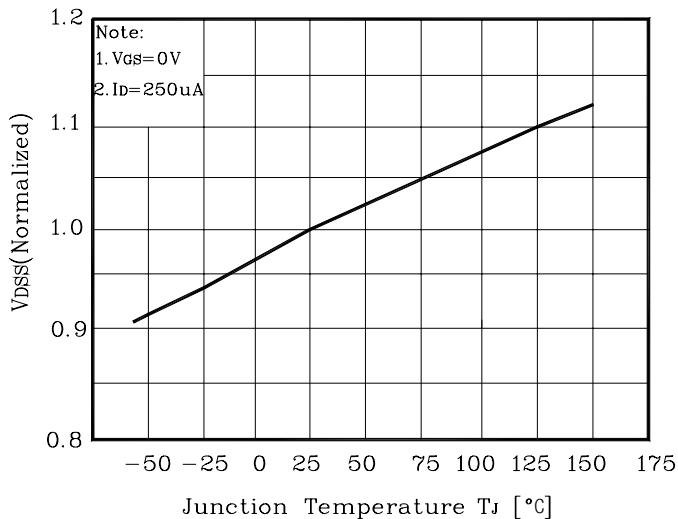


Fig. 8 $R_{DS(on)}$ - T_J

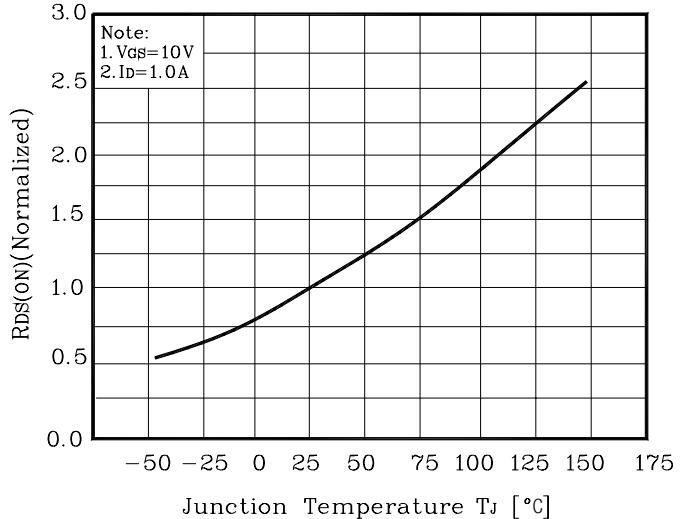


Fig. 9 I_D - T_c

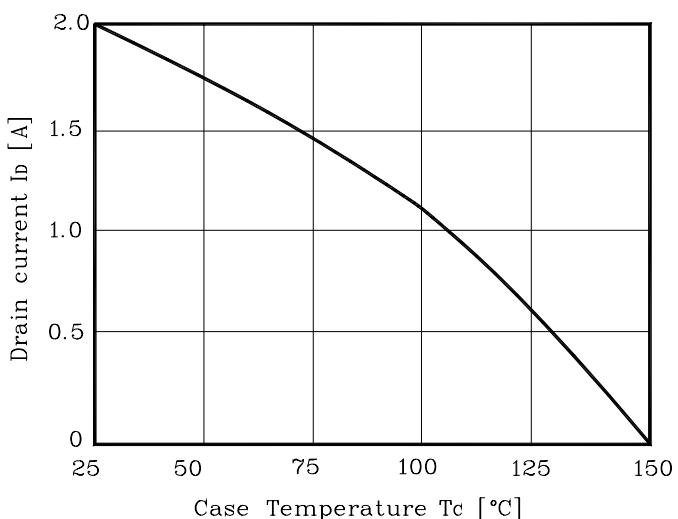


Fig. 10 Safe Operating Area

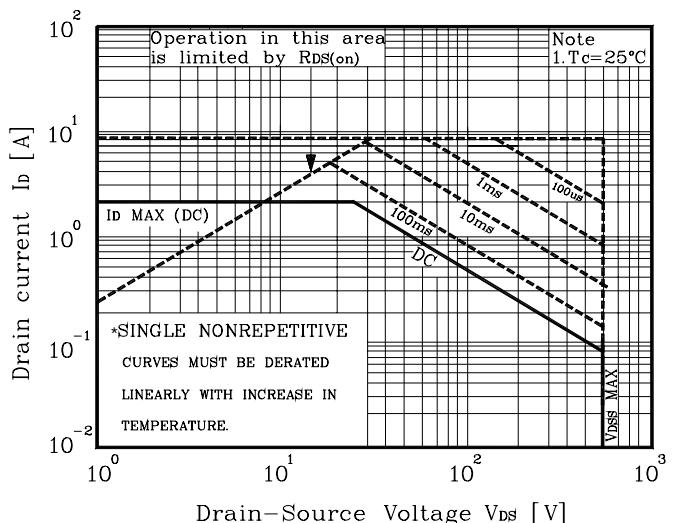


Fig. 11 Gate Charge Test Circuit & Waveform

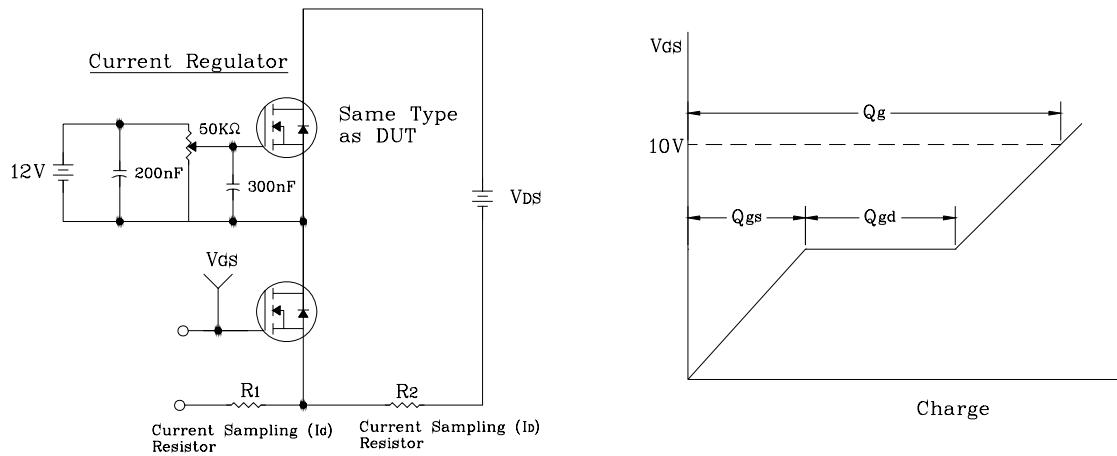


Fig. 12 Resistive Switching Test Circuit & Waveform

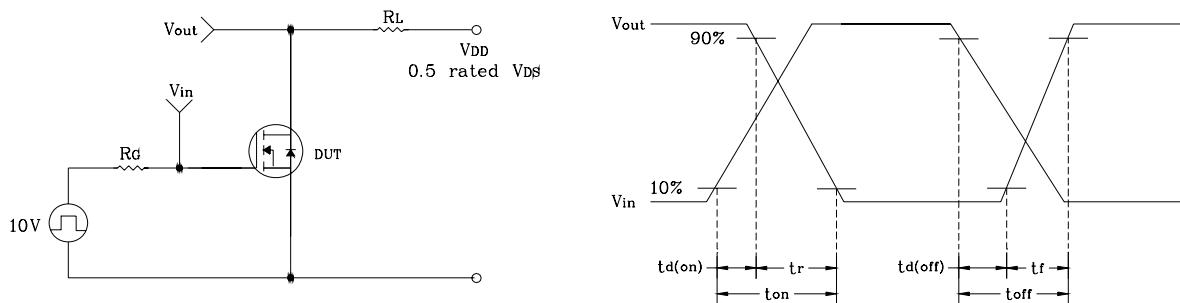


Fig. 13 E_{AS} Test Circuit & Waveform

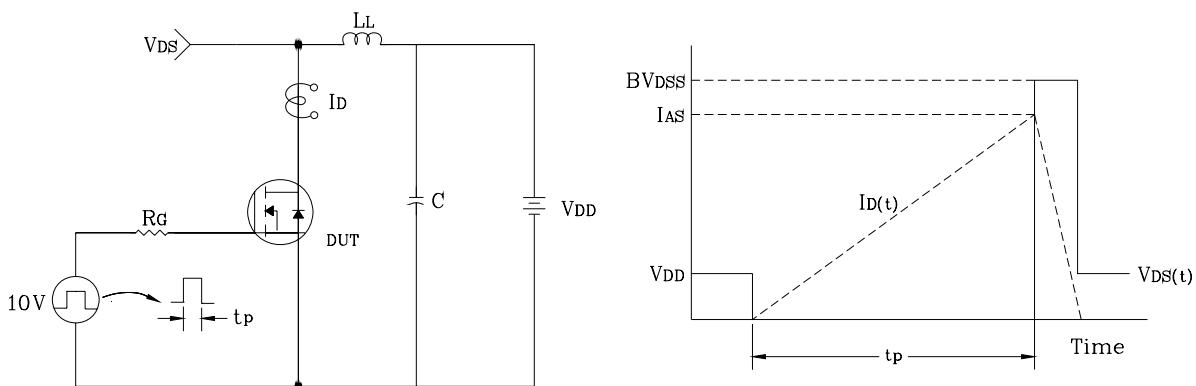
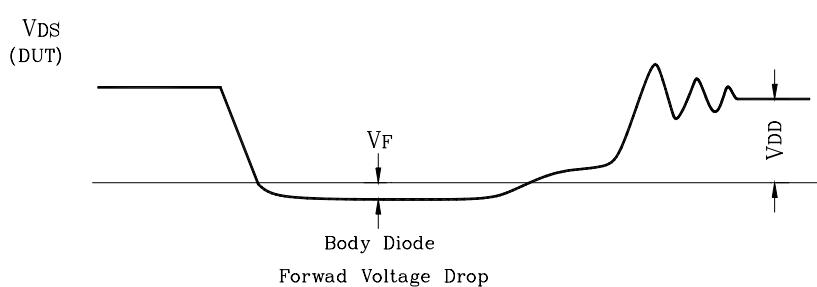
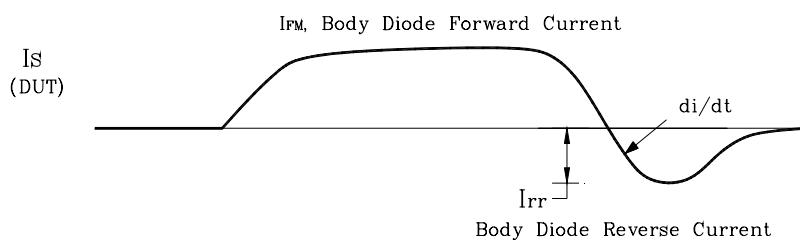
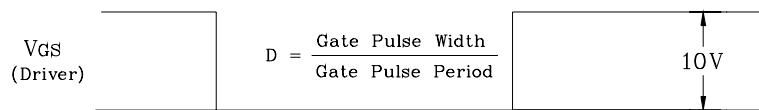
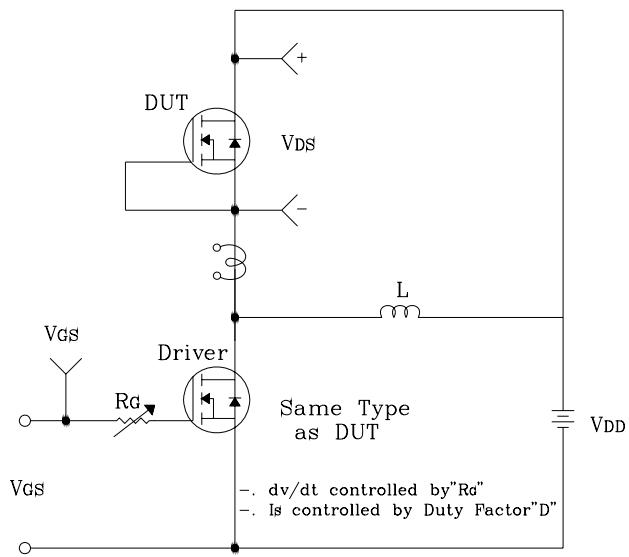
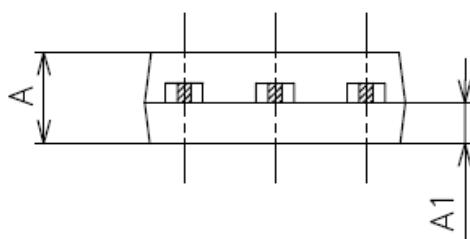
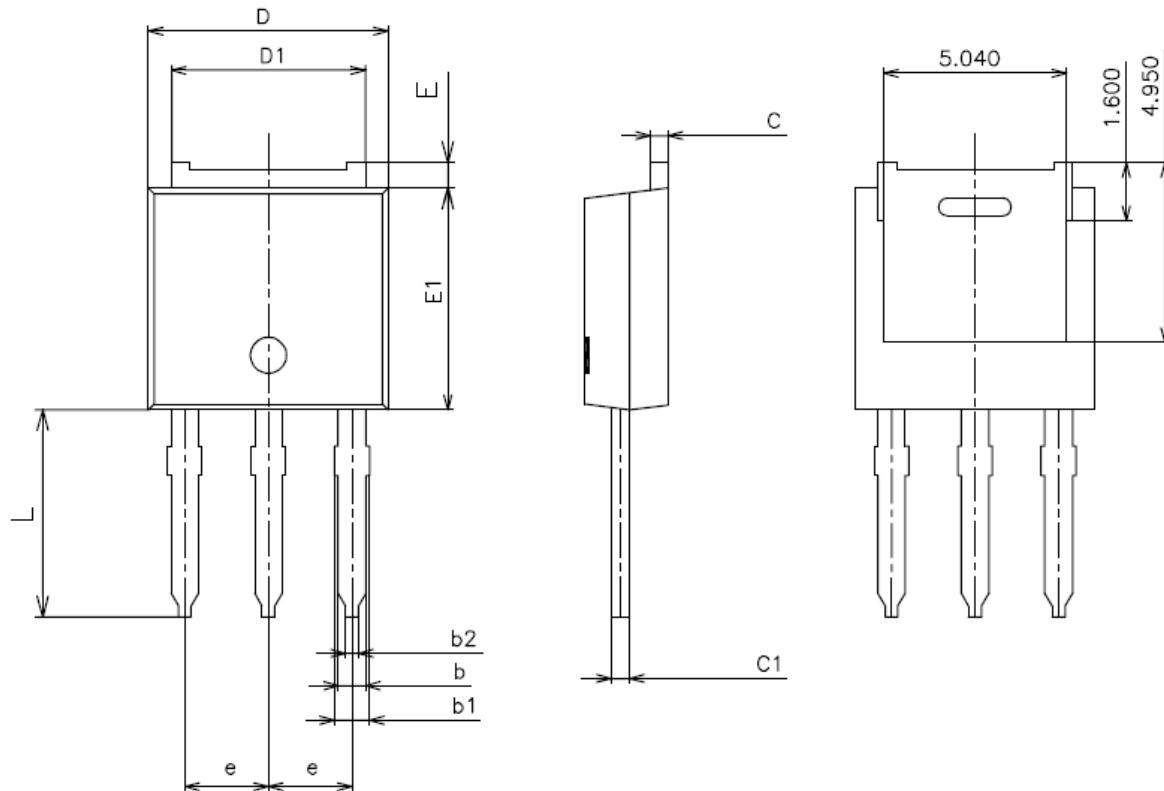


Fig. 14 Diode Reverse Recovery Time Test Circuit & Waveform



Package Outline Dimensions



SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
D	6.40	6.60	6.80	
D1	5.14	5.34	5.54	
E	0.50	0.70	0.90	
E1	5.90	6.10	6.30	
A	2.20	2.30	2.40	
A1	0.87	1.07	1.27	
C	0.40	0.50	0.60	
C1	0.40	0.50	0.60	
L	5.50	5.70	5.90	
b	0.66	0.76	0.86	
b1	0.82	1.02	1.22	
b2	0.25	0.35	0.45	
e	2.10	2.30	2.50	

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